



SamHop Microelectronics Corp.

**STM4446**

Ver 1.0

N-Channel Logic Level Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
40V	9A	16.5 @ VGS=10V
		26 @ VGS=4.5V

FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous ^a	9	A
	$T_A=25^\circ\text{C}$		
	$T_A=70^\circ\text{C}$	7.2	A
I_{DM}	-Pulsed ^b	45	A
E_{AS}	Single Pulse Avalanche Energy ^d	64	mJ
P_D	Maximum Power Dissipation ^a	2.5	W
	$T_A=25^\circ\text{C}$		
	$T_A=70^\circ\text{C}$	1.6	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient ^a	50	$^\circ\text{C/W}$
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STM446

Ver 1.0

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V , V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	2.1	3	V
R _{DSON}	Drain-Source On-State Resistance	V _{GS} =10V , I _D =4.5A		13	16.5	m ohm
		V _{GS} =4.5V , I _D =3.5A		19	26	m ohm
g _{FS}	Forward Transconductance	V _{DS} =10V , I _D =4.5A		18		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	V _{DS} =20V, V _{GS} =0V f=1.0MHz		845		pF
C _{OSS}	Output Capacitance			124		pF
C _{RSS}	Reverse Transfer Capacitance			100		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =20V I _D =1A V _{GS} =10V R _{GEN} = 6 ohm		17.6		ns
t _r	Rise Time			19		ns
t _{D(OFF)}	Turn-Off Delay Time			18.3		ns
t _f	Fall Time			32		ns
Q _g	Total Gate Charge	V _{DS} =20V, I _D =4.5A, V _{GS} =10V		14		nC
		V _{DS} =20V, I _D =4.5A, V _{GS} =4.5V		7.3		nC
Q _{gs}	Gate-Source Charge	V _{DS} =20V, I _D =4.5A, V _{GS} =10V		1.7		nC
Q _{gd}	Gate-Drain Charge			4.8		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =3A		0.8	1.3	V

Notes

- a. Surface Mounted on FR4 Board, t < 10sec.
- b. Pulse Test: Pulse Width < 300us, Duty Cycle < 2%.
- c. Guaranteed by design, not subject to production testing.
- d. Starting T_J=25 °C, L=0.5mH, V_{DD} = 20V. (See Figure13)

STM4446

Ver 1.0

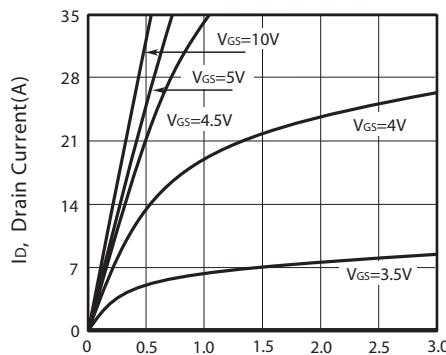


Figure 1. Output Characteristics

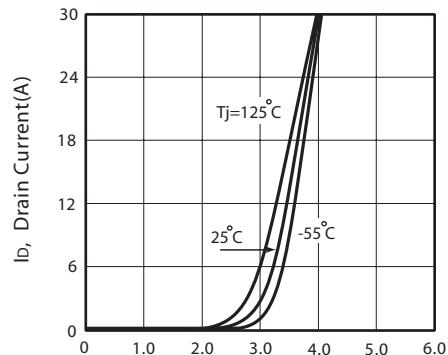


Figure 2. Transfer Characteristics

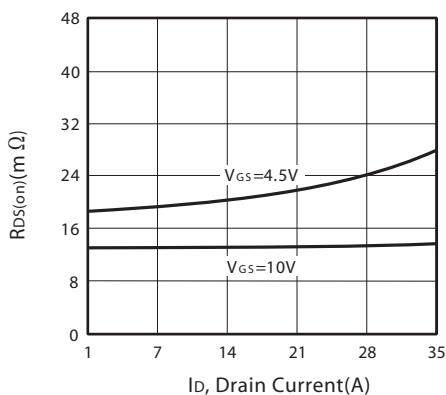


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

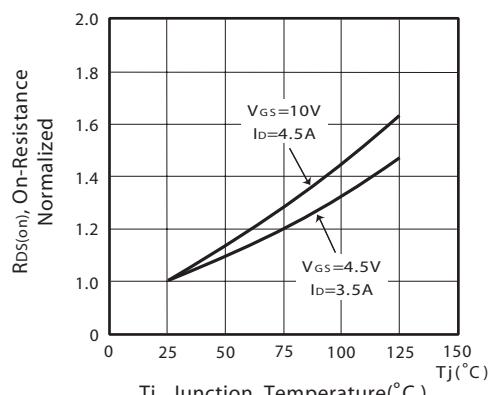


Figure 4. On-Resistance Variation with Drain Current and Temperature

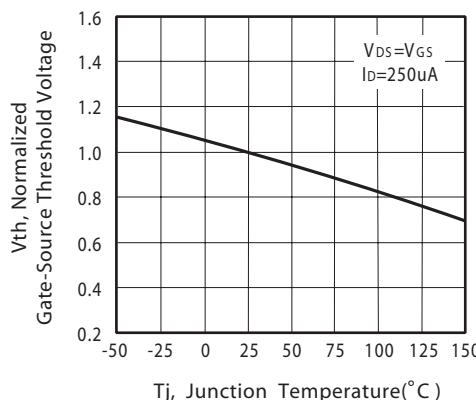


Figure 5. Gate Threshold Variation with Temperature

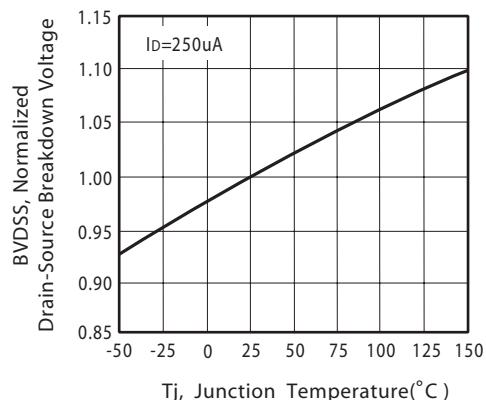
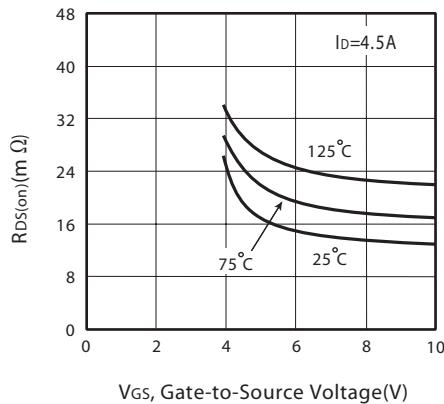


Figure 6. Breakdown Voltage Variation with Temperature

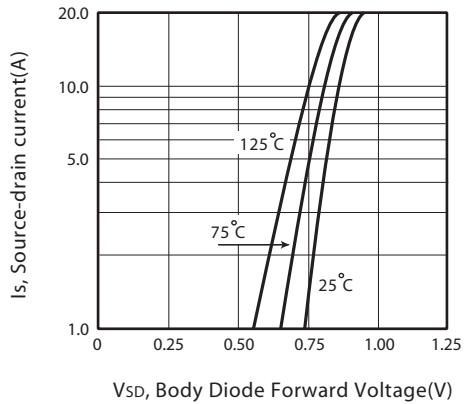
STM4446

Ver 1.0



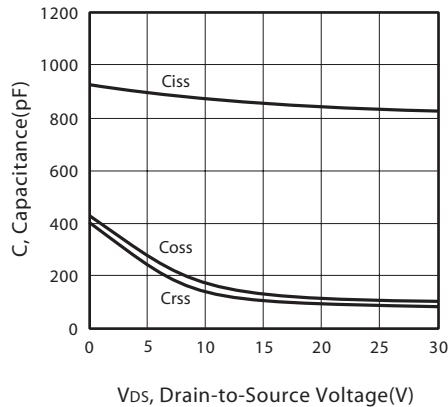
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



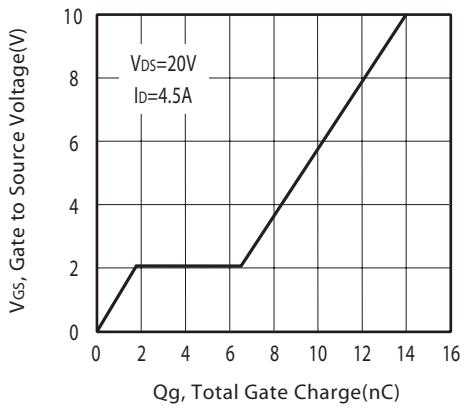
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



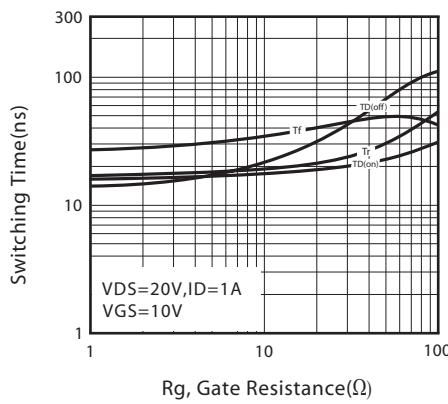
V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



Q_g , Total Gate Charge(nC)

Figure 10. Gate Charge



R_g, Gate Resistance(Ω)

Figure 11. switching characteristics

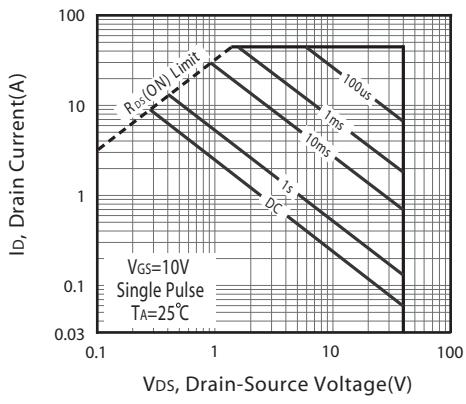
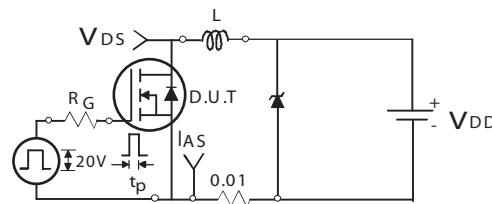


Figure 12. Maximum Safe Operating Area

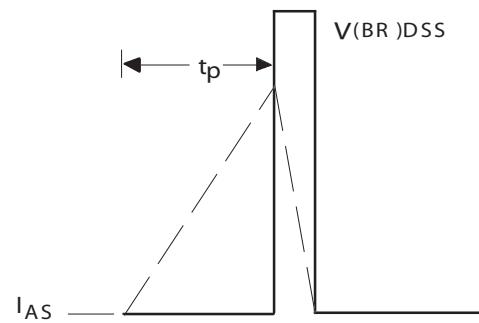
STM4446

Ver 1.0



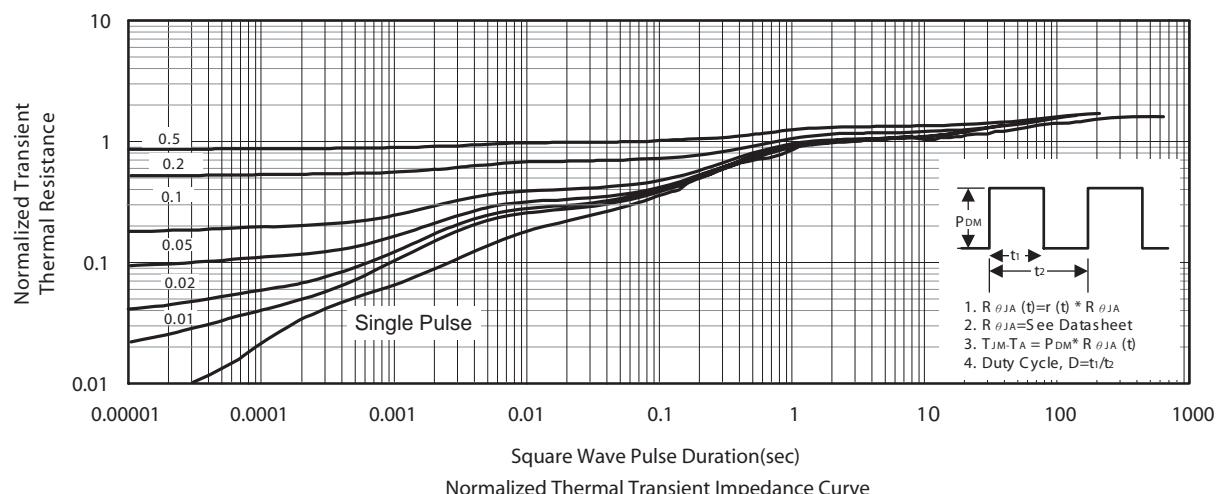
Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.



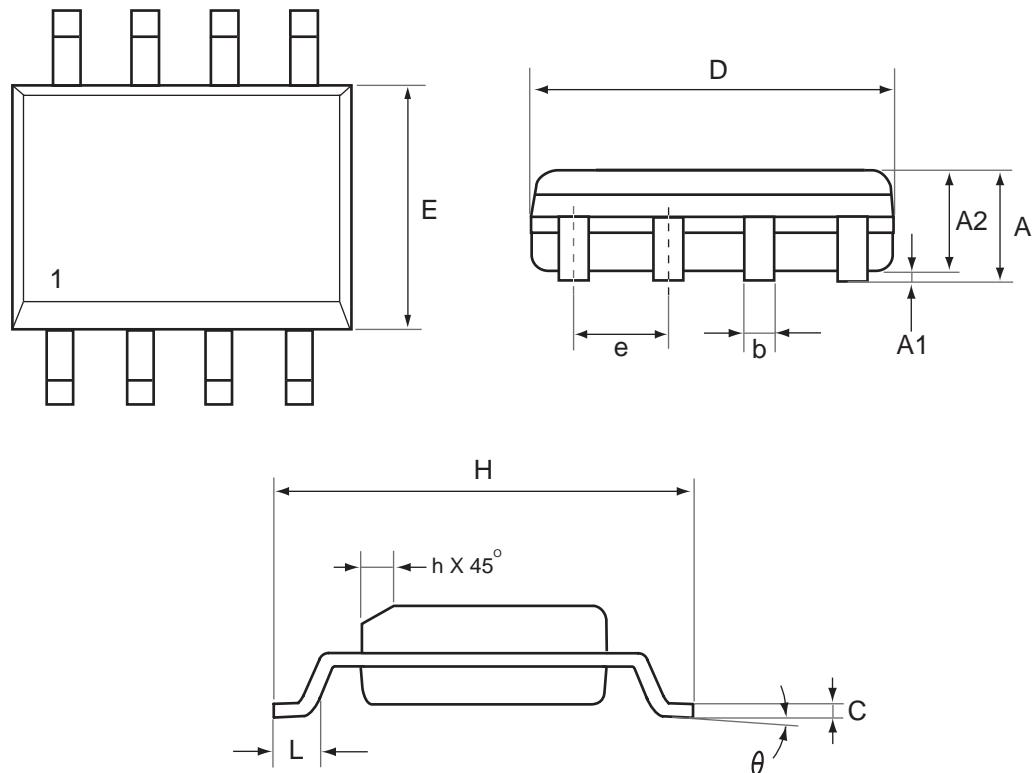
Dec,14,2012

STM446

Ver 1.0

PACKAGE OUTLINE DIMENSIONS

SO-8

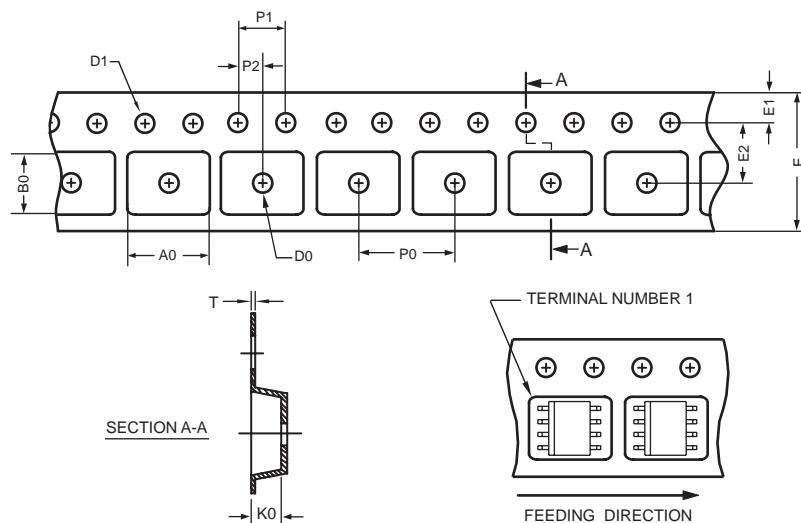


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	1.63	0.049	0.064
b	0.31	0.51	0.012	0.020
C	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	3.70	4.00	0.146	0.157
e	1.27 REF.		0.050 BSC	
H	5.80	6.20	0.228	0.244
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°
h	0.25	0.50	0.010	0.020

Dec,14,2012

SO-8 Tape and Reel Data

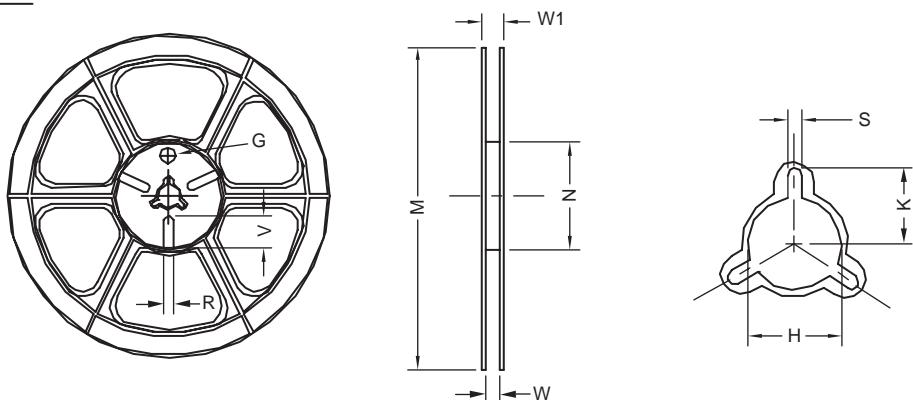
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ± 0.15	5.25 ± 0.10	2.10 ± 0.10	$\phi 1.5$ (MIN)	$\phi 1.55$ ± 0.10	12.0 $+0.3$ -0.1	1.75 ± 0.10	5.5 ± 0.10	8.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.10	0.30 ± 0.013

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 ± 1	62 ± 1.5	12.4 $+0.2$	16.8 -0.4	$\phi 12.75$ $+0.15$	---	2.0 ± 0.15	---	---	---